

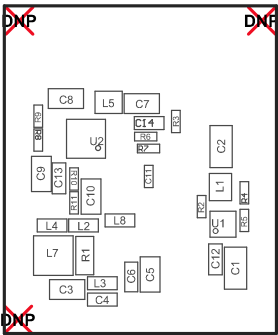
ZZ1 ■ Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.

ZZ2 ■ This Assembly Note will show in the PcbDoc and associated outputs

ZZ3 ■ This Assembly Note will show in the PcbDoc and associated outputs

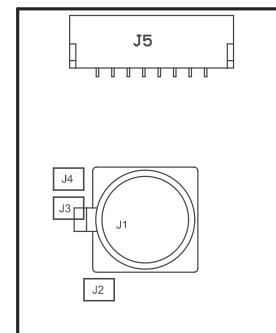
ZZ4 ■ This Assembly Note will show in the PcbDoc and associated outputs

LBL1



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-01491	REV: 001	SUN REV: Not In VersionControl
	TID #: 01491		
PLOT NAME = Top Assembly Drawing	GENERATED : 12/5/2017 5:22:09 PM	TEXAS INSTRUMENTS	



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-01491	REV: 001	SVN REV: Not In VersionControl
	TID #: 01491		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 12/5/2017 5:22:10 PM		TEXAS INSTRUMENTS

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